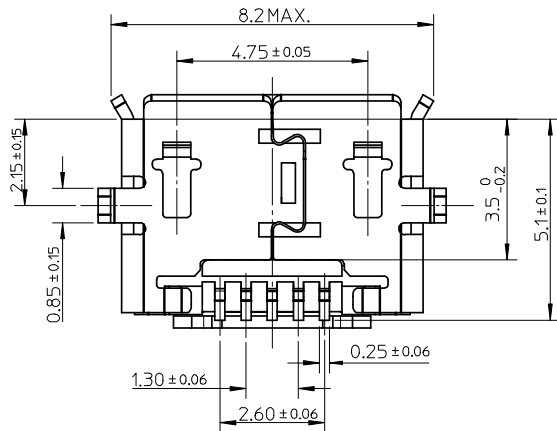
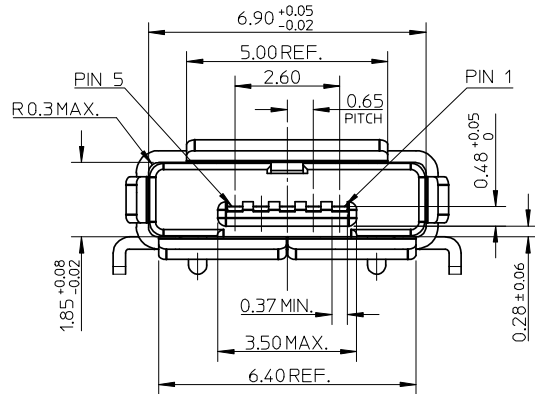
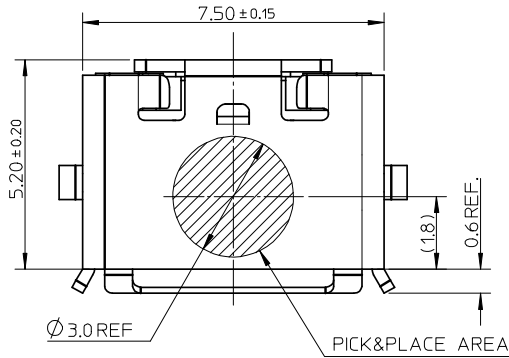
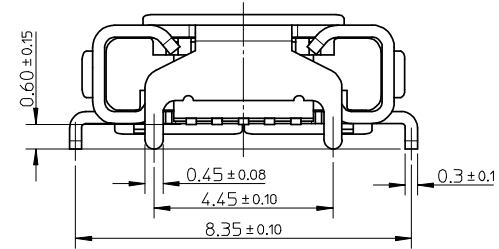
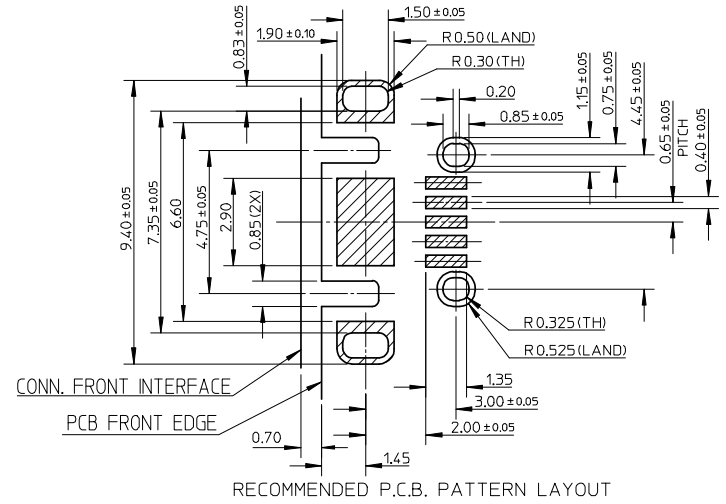


NOTE :

- MATERIAL :
HOUSING : LCP,BLACK,UL94V-0
TERMINAL : COPPER ALLOY THICKNESS = 0.15 MM
SHIELD CASE : STAINLESS STEEL THICKNESS = 0.30 MM
- PLATING :
TERMINAL: CONTACT AREA : GOLD FLASH (0.11 MICRON MIN.) OVER MINIMUM 0.75 MICRON Pd/Ni.
SOLDER TAIL AREA : GOLD FLASH (0.05 MICRON MIN.).
UNDER PLATING : NICKEL 2.0 MICROMN MINIMUM.
SHIELD : MATTE TIN 1.27 MICRON MINIMUM.
UNDER PLATING : NICKEL 1.27 MICRON MINIMUM.
- TAIL COPLANARITY 0.08 MM MAXIMUM.
- COMPLIANT TO RoHS DIRECTIVE 2002/95/EC AND ELV IDRECTIVE 2000/53/EC.



REVISE EC NO: SH2008-0619 DRWN:X JSONG CHK'D:X JSONG APPR:HWANG	DESCRIPTION	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 1:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
				mm	INCH	DRAWN BY X JSONG	DATE 2007/03/15	TITLE MICRO USB AB REC. TOP MOUNT ASS'Y		
			4 PLACES	± ---	± ---	CHECKED BY JTIAN	DATE 2007/03/15			
			3 PLACES	± ---	± ---	APPROVED BY JNCHEN	DATE 2007/03/15	MOLEX MOLEX INCORPORATED		
			2 PLACES	± 0.15	± ---	MATERIAL NO. 47590-0001				
B	REV		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		SIZE A3		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION			
			1 PLACE		± 0.25	± ---	ANGULAR ± 3 °			